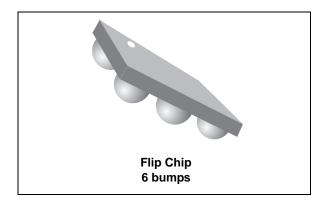
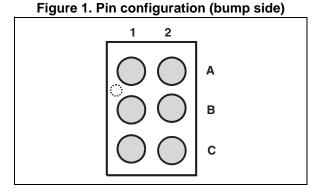




Common mode filter with ESD protection

Datasheet - production data





Features

- · Very large differential bandwidth
- · Very low PCB space consumption
- High ESD robustness: IEC 61000-4-2 level 4
- Withstand 1000 ESD strikes
- Lead-free Flip-Chip package
- Small footprint
- Very low profile

Complies with the following standard:

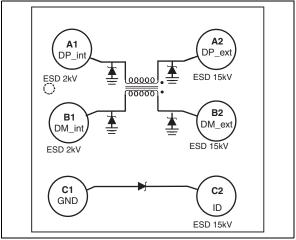
- IEC 61000-4-2 level 4:
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)

Applications

Where transient overvoltage protection in ESD sensitive equipment is required such as:

- Mobile phones
- Computers
- Portable navigation devices
- · Digital still cameras
- · Portable multimedia players

Figure 2. Schematic (bump side)



Description

The ECMF02-3F3 is a highly integrated common mode filter designed to suppress EMI/RFI common mode noise on high speed differential serial buses.

TM: IPAD is a trademark of STMicroelectronics.

Characteristics ECMF02-3F3

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25 \text{ °C}$)

Symbol	Parameter	Value	Unit
V _{PP}	IEC 61000-4-2 (C = 150 pF, R = 330 Ω) External pins (A2, B2 and C2): level 4 Air discharge Contact discharge Internal pins (A1, B1): level 1 Air discharge Contact discharge	15 8 2 2	kV
P _d	Line resistance power dissipation at 85 °C (top max)	60	mW
T _j	Operating temperature range	- 30 to + 85	°C
T _{stg}	Storage temperature range	- 55 to 150	°C

Figure 3. Electrical characteristics (definitions)

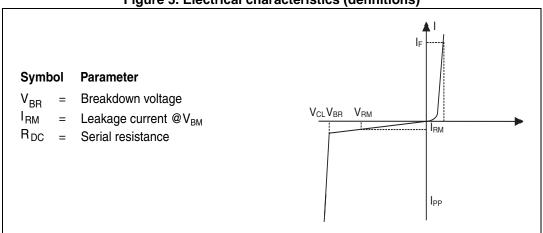
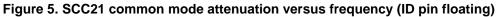


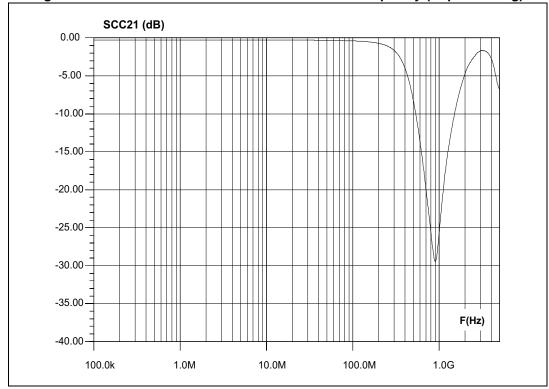
Table 2. Electrical characteristics (values, $T_{amb} = 25$ °C)

		u.i.i			
Symbol	Test conditions	Min.	Тур.	Max.	Unit
V_{BR}	I _R = 1 mA	6			V
I _{RM}	V _{RM} = 3 V per line			100	nA
R _{DC}	DC serial resistance		3.4	4.5	Ω

ECMF02-3F3 Characteristics

Figure 4. SDD21 differential attenuation versus frequency





Characteristics ECMF02-3F3

SDD11 / SDD22 (dB) 0.00 -5.00 -10.00 -15.00 SDD22 -20.00 -25.00 SDD11 -30.00 -35.00 F(Hz) -40.00

Figure 6. SDD11 / SDD22 differential return loss versus frequency (ID pin floating)



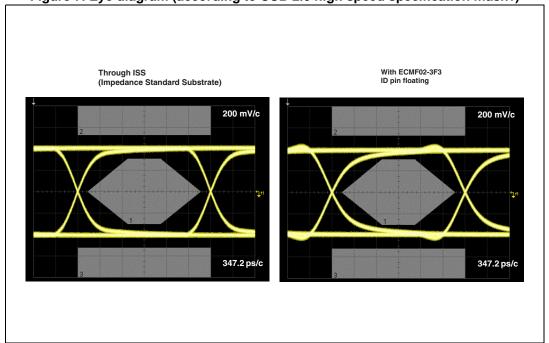
10.0M

100.0M

1.0G

100.0k

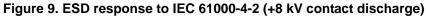
1.0M

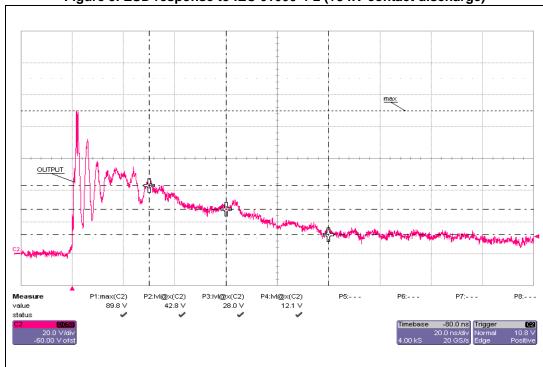


ECMF02-3F3 Characteristics



Figure 8. TDR: $Z_{0 \text{ DIFF}}$ = 100 Ω , t_{R} = 400 ps (10% - 90%),





Characteristics ECMF02-3F3

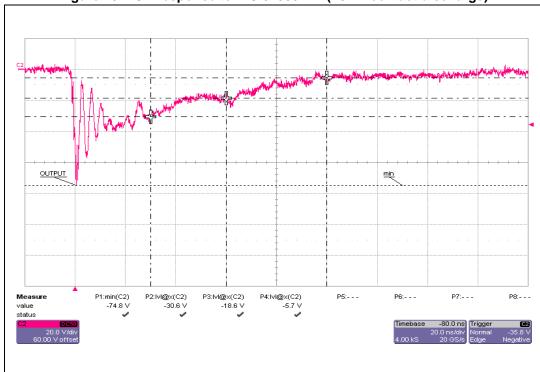


Figure 10. ESD response to IEC 61000-4-2 (- 8 kV contact discharge)

2 USB 2.0 application schematic

D+

DP ext

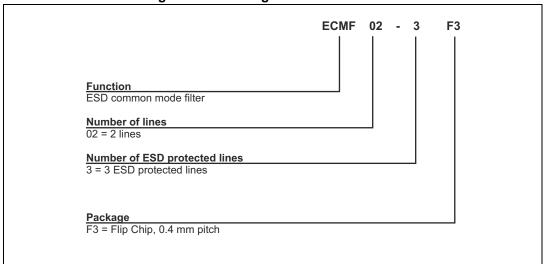
ESD 15kV

ESD

Figure 11. Application schematic

3 Ordering information scheme

Figure 12. Ordering information scheme



ECMF02-3F3 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

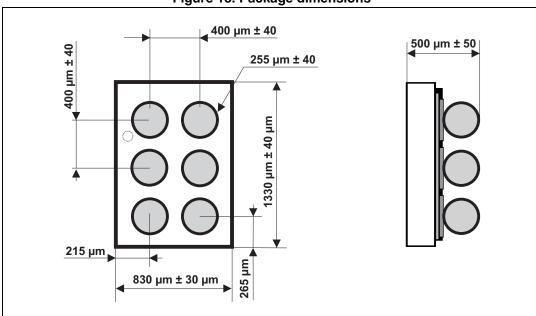
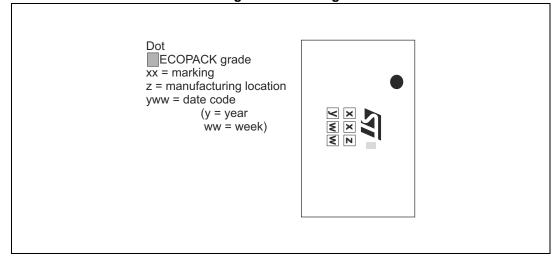


Figure 13. Package dimensions

Figure 14. Marking



Package information ECMF02-3F3

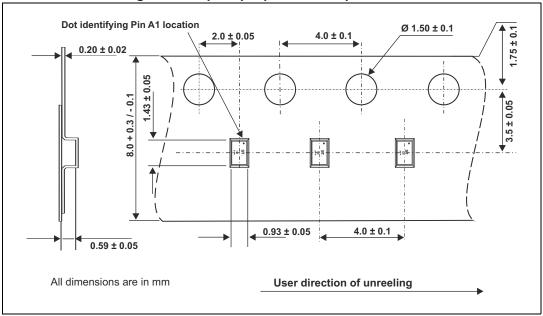
Copper pad Diameter:
220 µm recommended
260 µm maximum

Solder mask opening:
300 µm minimum

Solder stencil opening:
220 µm recommended

Figure 15. Footprint recommendations





Note:

More information is available in the application notes:

AN2348, "IPAD™ 400 µm Flip Chip: package description and recommendations for use" AN1751, "EMI filters: recommendations and measurements"

5 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ECMF02-3F3	KH	Flip Chip	1.2 mg	5000	Tape and reel 7"

6 Revision history

Table 4. Document revision history

Date	Revision	Changes
19-Nov-2012	1	Initial release.
22-May-2013	2	Moved dot position in <i>Figure 13</i> . Moved arrow in <i>Figure 16</i> to point to pin A1 location.
19-Dec-2013	3	Corrected typographical error in Figure 13.

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P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD101-B1-02ELS E6327 ESD112-B1-02EL E6327
ESD119B1W01005E6327XTSA1 ESD5V0J4-TP ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF
3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7
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CPDQC5V0-HF D1213A-01LP4-7B D1213A-02WL-7 ESDLIN1524BJ-HQ 5KP100A